

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6212721

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	RELEASE OF SECURITY INTEREST	
CONVEYING PARTY DATA		
	Name	Execution Date
	CITIBANK, N.A.	07/21/2020
RECEIVING PARTY DATA		
Name:	COMTECH TELECOMMUNICATIONS CORP.	
Street Address:	68 SOUTH SERVICE RD.	
Internal Address:	SUITE 230	
City:	MELVILLE	
State/Country:	NEW YORK	
Postal Code:	11747	
Name:	COMTECH EF DATA CORP.	
Street Address:	2114 WEST 7TH STREET	
City:	TEMPE	
State/Country:	ARIZONA	
Postal Code:	85281	
Name:	COMTECH XICOM TECHNOLOGY, INC.	
Street Address:	3550 BASSETT STREET	
City:	SANTA CLARA	
State/Country:	CALIFORNIA	
Postal Code:	95054	
Name:	COMTECH SYSTEMS, INC.	
Street Address:	212 OUTLOOK POINT DRIVE	
Internal Address:	SUITE 100	
City:	ORLANDO	
State/Country:	FLORIDA	
Postal Code:	32809	
Name:	COMTECH PST CORP.	
Street Address:	105 BAYLIS RD.	
City:	MELVILLE	
State/Country:	NEW YORK	
Postal Code:	11747	
Name:	COMTECH MOBILE DATACOM CORPORATION	

PATENT

Street Address:	20430 CENTURY BOULEVARD
City:	GERMANTOWN
State/Country:	MARYLAND
Postal Code:	20874
Name:	ANGELS ACQUISITION CORP.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	ARMER COMMUNICATIONS ENGINEERING SERVICES, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH AEROASTRO, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH ANTENNA SYSTEMS, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH COMMUNICATIONS CORP.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH COMSTREAM, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK

PATENT

REEL: 053279 FRAME: 0036

Postal Code:	11747
Name:	COMTECH SYSTEMS INTERNATIONAL, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH TOLT TECHNOLOGIES, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	TIERNAN RADYNE COMSTREAM, INC.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH CPI ELECTRON DEVICES CORP.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	COMTECH CPI MICROWAVE CORP.
Street Address:	68 SOUTH SERVICE RD.
Internal Address:	SUITE 230
City:	MELVILLE
State/Country:	NEW YORK
Postal Code:	11747
Name:	TELECOMMUNICATION SYSTEMS, INC.
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	NETWORKS IN MOTION, INC.
Street Address:	275 WEST STREET

PATENT

REEL: 053279 FRAME: 0037

Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	SOLVERN INNOVATIONS, INC.
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	MICRODATA, LLC
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	MICRODATA GIS, INC.
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	MAPLE ACQUISITION LLC
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	NEXTGEN COMMUNICATIONS, INC., A CORPORATION OF MARYLAND
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401
Name:	NEXTGEN COMMUNICATIONS, INC., A CORPORATION OF VIRGINIA
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND

PATENT

REEL: 053279 FRAME: 0038

Postal Code:	21401
Name:	OLIVE ACQUISITION LLC
Street Address:	275 WEST STREET
Internal Address:	SUITE 400
City:	ANNAPOLIS
State/Country:	MARYLAND
Postal Code:	21401

PROPERTY NUMBERS Total: 3

Property Type	Number
Patent Number:	7917285
Patent Number:	8606503
Patent Number:	9261365

CORRESPONDENCE DATA

Fax Number: (617)526-9899

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6175269454

Email: dherra@proskauer.com

Correspondent Name: PROSKAUER ROSE LLP

Address Line 1: ONE INTERNATIONAL PLACE

Address Line 4: BOSTON, MASSACHUSETTS 02110

NAME OF SUBMITTER:	JASON P. COLANGELO
SIGNATURE:	/Jason P. Colangelo, #75,238/
DATE SIGNED:	07/22/2020

Total Attachments: 4

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This RELEASE OF SECURITY INTEREST IN PATENT LICENSES dated as of July 21, 2020 (this “Release”), is made by CITIBANK, N.A., as the administrative agent for the Secured Parties (in such capacity, the “Administrative Agent”), in favor of Comtech Telecommunications Corp. and the Subsidiary Loan Parties party to the 2018 Patent Security Agreement (as defined below) (collectively, the “Grantors”).

A. Reference is made to (i) the Guarantee and Collateral Agreement, dated as of February 23, 2016 (as amended, amended and restated, supplemented or otherwise modified from time to time, the “Collateral Agreement”), among Comtech Telecommunications Corp., a Delaware corporation (the “Borrower”), the Subsidiaries from time to time party thereto and the Administrative Agent; (ii) the First Amended and Restated Credit Agreement, dated as of October 31, 2018 (as amended, amended and restated, supplemented or otherwise modified from time to time, the “Credit Agreement”), among the Borrower, the Lenders from time to time party thereto and the Administrative Agent; and (iii) the Patent Security Agreement dated as of November 6, 2018, among the Borrower, the Subsidiary Loan Parties from time to time party thereto and the Administrative Agent (the “2018 Patent Security Agreement” and, together with the Collateral Agreement, the “Security Agreements”).

B. Pursuant to the Security Agreements, the Grantors assigned, pledged and granted to the Administrative Agent, its successors and assigns, for the benefit of the Secured Parties, a security interest in all right, title and interest of the Grantors in, to and under, among other things, the Patent Collateral (as defined in the 2018 Patent Security Agreement), and pursuant to the 2018 Patent Security Agreement such security interest was recorded with the United States Patent & Trademark Office (the “USPTO”) on November 16, 2018 at Reel/Frame 048104/0080.

C. The Patent Licenses granted to TeleCommunication Systems, Inc., a Delaware corporation, set forth in Schedule I hereto (the “Released Patent Licenses”), were among the Patent Collateral included on the schedules attached to the 2018 Patent Security Agreement.

D. The Administrative Agent hereby executes this Release to remove the Released Patent Licenses from the schedules attached to the 2018 Patent Security Agreement.

Accordingly, the Administrative Agent, on behalf of the Secured Parties, does hereby state as follows:

SECTION 1. Terms. Each capitalized term used but not otherwise defined herein shall have the meaning specified in the Credit Agreement, the Collateral Agreement or the 2018 Patent Security Agreement, as applicable.

SECTION 2. Release. The Administrative Agent, on behalf of itself, the Secured Parties and their permitted successors and assigns, hereby (i) releases its lien and

security interest granted under the 2018 Patent Security Agreement in the Released Patent Licenses and (ii) assigns, transfers and conveys to the Grantors any and all right, title and interest it may have in the Released Patent Licenses under the 2018 Patent Security Agreement. For the avoidance of doubt, this Release does not release any lien or security interest of the Administrative Agent granted under the Collateral Agreement in any Released Patent Licenses. This Release is made without representation or warranty by, or recourse to, the Administrative Agent, or any other Secured Party.

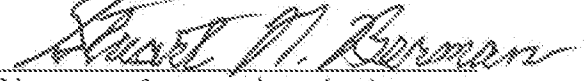
SECTION 3. Further Assurances. The Administrative Agent hereby authorizes the Grantors or the Grantors' designated representative to record this Release with the USPTO at the Grantors' sole expense.

THIS RELEASE SHALL BE CONSTRUED IN ACCORDANCE WITH
AND GOVERNED BY THE LAWS OF THE STATE OF NEW YORK.

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IN WITNESS WHEREOF, the Administrative Agent has caused this
Release to be duly executed as of the day and year first written above.

CITIBANK, N.A.,
as Administrative Agent

By 
Name: Stuart N. Berman
Title: Authorized Signatory

[Signature Page to Patent License Release]

[[5485484]]

SCHEDULE I

Released Patent Licenses Granted to TeleCommunication Systems, Inc.

Owner/Licensor	Type	Registration Number	Title	Registration Date
GEOGRAPHIC LOCATION INNOVATIONS, LLC	Utility	7,917,285	Device, system and method for remotely entering, storing and sharing addresses for a positional information device	March 29, 2011
ROTHSCHILD LOCATION TECHNOLOGIES LLC	Utility	8,606,503	Device, system and method for remotely entering, storing and sharing addresses for a positional information device	December 10, 2013
SOCIAL POSITIONING INPUT SYSTEMS, LLC	Utility	9,261,365	Device, system and method for remotely entering, storing and sharing addresses for a positional information device	February 16, 2016